IEEE 802 July 2021 Electronic Plenary

IEEE 802.3 Ethernet WG Closing Plenary 22 Jul 2021

IEEE 802.3 Beyond 400 Gb/s Ethernet SG Closing Report



IEEE P802.3 B400G Study Group Project information

- Study Group Organization
 - John D'Ambrosia, Study Group Chair
 - Tom Issenhuth, Study Group Recording Secretary
- Task force web and reflector information
 - Reflector information: <u>https://www.ieee802.org/3/B400G/reflector.html</u>
 - Home page: <u>https://www.ieee802.org/3/B400G/index.html</u>

Activities This Plenary Session

- 13 July
 - Approved requesting rechartering of Study Group
 - 3 Technical Presentations
 - Project Documentation Revisited, John D'Ambrosia (Futurewei)
 - Case for inclusion of a 200GBASE-DR objective, Rob Stone (Facebook)
 - Enabling dense 200GbE and 400GbE, Kapil Shrikhande (Innovium)
 - Adopted objectives related to 200 Gb/s and 400 Gb/s AUIs & PMDs (see next Pages)
- 20 July
 - 3 Technical Presentations
 - Coherent-Lite for Beyond 400GigE, Cedric Lam (Google)
 - Considerations on the "10km @ 800Gb/s" objective, Tingting Zhang (Huawei)
 - 16-lane 1.6TbE AUI Objective Proposal: A test & measurement perspective, Paul Brooks (Viavi)
 - Adopted objective related to 16 lane AUI for 1.6 Tb/s (See next pages)
 - Approved two liaisons (OIF / ITU-T SG15)

B400G Adopted Objectives

Non-Rate Specific

- Support full-duplex operation only *
- Preserve the Ethernet frame format utilizing the Ethernet MAC *
- Preserve minimum and maximum FrameSize of current IEEE 802.3 standard *
- Support a BER of better than or equal to 10 -13 at the MAC/PLS service interface (or the frame loss ratio equivalent) **
- Provide support to enable mapping over OTN ***
- 200 Gb/s Related
 - Support a MAC data rate of 200 Gb/s ##
 - Support optional single-lane 200 Gb/s attachment unit interfaces for chip-to-module and chipto-chip applications ##
 - Define a physical layer specification that supports 200 Gb/s operation:
 - over 1 pair of SMF with lengths up to at least 500 m ##
 - over 1 pair of SMF with lengths up to at least 2 km ##
- 400 Gb/s Related
 - Support a MAC data rate of 400 Gb/s ##
 - Support optional two-lane 400 Gb/s attachment unit interfaces for chip-to-module and chip-tochip applications ##
 - Define a physical layer specification that supports 400 Gb/s operation:
 - over 2 pairs of SMF with lengths up to at least 500 m ##

* Adopted by B400G SG, Apr 2021
** Adopted by B400G SG Apr 26, 2021
*** Adopted by B400G SG May 3, 2021
**** Adopted by B400G SG May 17, 2021
Adopted by B400G SG Jun 3, 2021
Adopted by B400G SG Jul 13, 2021
Adopted by B400G SG Jul 20, 2021

Approval by 802.3 WG Pending

B400G Adopted Objectives

800 Gb/s Related

- Support a MAC data rate of 800 Gb/s *
- Support optional eight-lane 800 Gb/s attachment unit interfaces for chip-to-module and chip-to-chip applications ****
- Support optional four-lane 800 Gb/s attachment unit interfaces for chip-to-module and chip-to-chip applications ****
- Define a physical layer specification that supports 800 Gb/s operation:
 - over 8 pairs of MMF with lengths up to at least 50 m *
 - over 8 pairs of MMF with lengths up to at least 100 m *
 - over 8 pairs of SMF with lengths up to at least 500 m *
 - over 8 pairs of SMF with lengths up to at least 2 km #
 - over 4 pairs of SMF with lengths up to at least 500 m *
 - over 4 pairs of SMF with lengths up to at least 2 km *
 - over 4 wavelengths over a single SMF in each direction with lengths up to at least 2 km *
 - over a single SMF in each direction with lengths up to at least 10 km *
 - over a single SMF in each direction with lengths up to at least 40 km *

1.6 Tb/s Related

- Support a MAC data rate of 1.6 Tb/s #
- Support optional sixteen-lane 1.6 Tb/s attachment unit interfaces for chip-to-module and chip-to-chip applications ###
- Support optional eight-lane 1.6 Tb/s attachment unit interfaces for chip-to-module and chip-to-chip applications #
- Define a physical layer specification that supports 1.6 Tb/s operation:
 - over 8 pairs of SMF with lengths up to at least 500 m #
 - over 8 pairs of SMF with lengths up to at least 2 km #

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- #
- Adopted by B400G SG Jul 13, 2021 ##
- ### Adopted by B400G SG Jul 20, 2021
 - Approval by 802.3 WG Pending

WG Motion

- Move that the IEEE 802.3 Working Group request the re-chartering of the IEEE 802.3 Beyond 400 Gb/s Ethernet Study Group.
- Moved by: John D'Ambrosia
- Second: Matt Brown
- Technical (>=75%)
- Results (802.3 Voters) (y/n/a)
- Motion:

WG Motion

- Move that the IEEE 802.3 Working Group approve
 - IEEE_802d3_to_ITU_b400g_0721_draft.pdf
 - IEEE_802d3_to_OIF_b400g_0721_draft.pdf
- with editorial license granted to the Chair (or his appointed agent) as liaison communication from the IEEE 802.3 Working Group to ITU-T SG15 and OIF
- Moved by: John D'Ambrosia
- Second: Steve Trowbridge
- Technical (>=75%)
- Results (802.3 Voters) (y/n/a)
- Motion:

Future Meetings

- July 2021 Session
 - = Tues, Jul 13, 10am to 1pm ET = Tues, Jul 20, 10am to 1pm ET
 - Thurs, Jul 29, 10am to 1pm ET
- Aug 2021 Session
 - Thurs, Aug 12, 10am to 1pm ET
 - Thurs, Aug 19, 10am to 1pm ET (Tentative)
 - Thurs, Aug 26, 10am to 1pm ET

THANK YOU!



22 July 2021

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